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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	32MHz
Connectivity	I ² C, IrDA, SCI, SPI, SSI, USB OTG
Peripherals	DMA, LCD, LVD, POR, PWM, WDT
Number of I/O	80
Program Memory Size	384KB (384K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	64K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 17x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	100-TFLGA
Supplier Device Package	100-TFLGA (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f51137adlj-2a

Table 1.4 Pin Functions (3/4)

Classifications	Pin Name	I/O	Description
Serial communications interface (SCIf)	• Asynchronous mode/clock synchronous mode		
	SCK12	I/O	Input/output pin for the clock.
	RXD12	Input	Input pin for receiving data.
	TXD12	Output	Output pin for transmitting data.
	CTS12#	Input	Input pin for controlling the start of transmission and reception.
	RTS12#	Output	Output pin for controlling the start of transmission and reception.
	• Simple I ² C mode		
	SSCL12	I/O	Input/output pin for the I ² C clock.
	SSDA12	I/O	Input/output pin for the I ² C data.
	• Simple SPI mode		
	SCK12	I/O	Input/output pin for the clock.
	SMISO12	I/O	Input/output pin for slave transmit data.
	SMOSI12	I/O	Input/output pin for master transmit data.
	SS12#	Input	Chip-select input pin.
	• Extended serial mode		
	RXDX12	Input	Input pin for data reception by SCIf.
	TXDX12	Output	Output pin for data transmission by SCIf.
	SIOX12	I/O	Input/output pin for data reception or transmission by SCIf.
	I ² C bus interface	SCL0	I/O
SDA0		I/O	Input/output pin for I ² C bus interface data. Bus can be directly driven by the N-channel open drain output.
Serial peripheral interface	RSPCKA	I/O	Input/output pin for the RSPI clock.
	MOSIA	I/O	Input/output pin for transmitting data from the RSPI master.
	MISOA	I/O	Input/output pin for transmitting data from the RSPI slave.
	SSLA0	I/O	Input/output pin to select the slave for the RSPI.
	SSLA1 to SSLA3	Output	Output pins to select the slave for the RSPI.
Serial sound interface	SSISCK0	I/O	SSI serial bit clock pin.
	SSIWS	I/O	Word selection pin.
	SSITXD0	Output	Serial data output pin.
	SSIRXD0	Input	Serial data input pin.
	AUDIO_MCLK	Input	Master clock pin for audio.
USB 2.0 host/function module	USB0_DP	I/O	D+ I/O pin of the USB on-chip transceiver.
	USB0_DM	I/O	D- I/O pin of the USB on-chip transceiver.
	USB0_VBUS	Input	USB cable connection monitor pin.
	USB0_EXICEN	Output	Low-power control signal for the OTG chip.
	USB0_VBUSEN	Output	VBUS (5 V) supply enable signal for the OTG chip.
	USB0_OVRCURA, USB0_OVRCURB	Input	External overcurrent detection pins.
	USB0_ID	Input	Mini-AB connector ID input pin during operation in OTG mode.
12-bit A/D converter	AN000 to AN015, AN021	Input	Input pins for the analog signals to be processed by the A/D converter.
	ADTRG0#	Input	Input pin for the external trigger signals that start the A/D conversion.
12-bit D/A converter	DA0, DA1	Output	Output pins for the analog signals to be processed by the D/A converter.

1.5 Pin Assignments

Figure 1.3 to Figure 1.5 show the pin assignments. Table 1.5 to Table 1.7 show the lists of pins and pin functions.

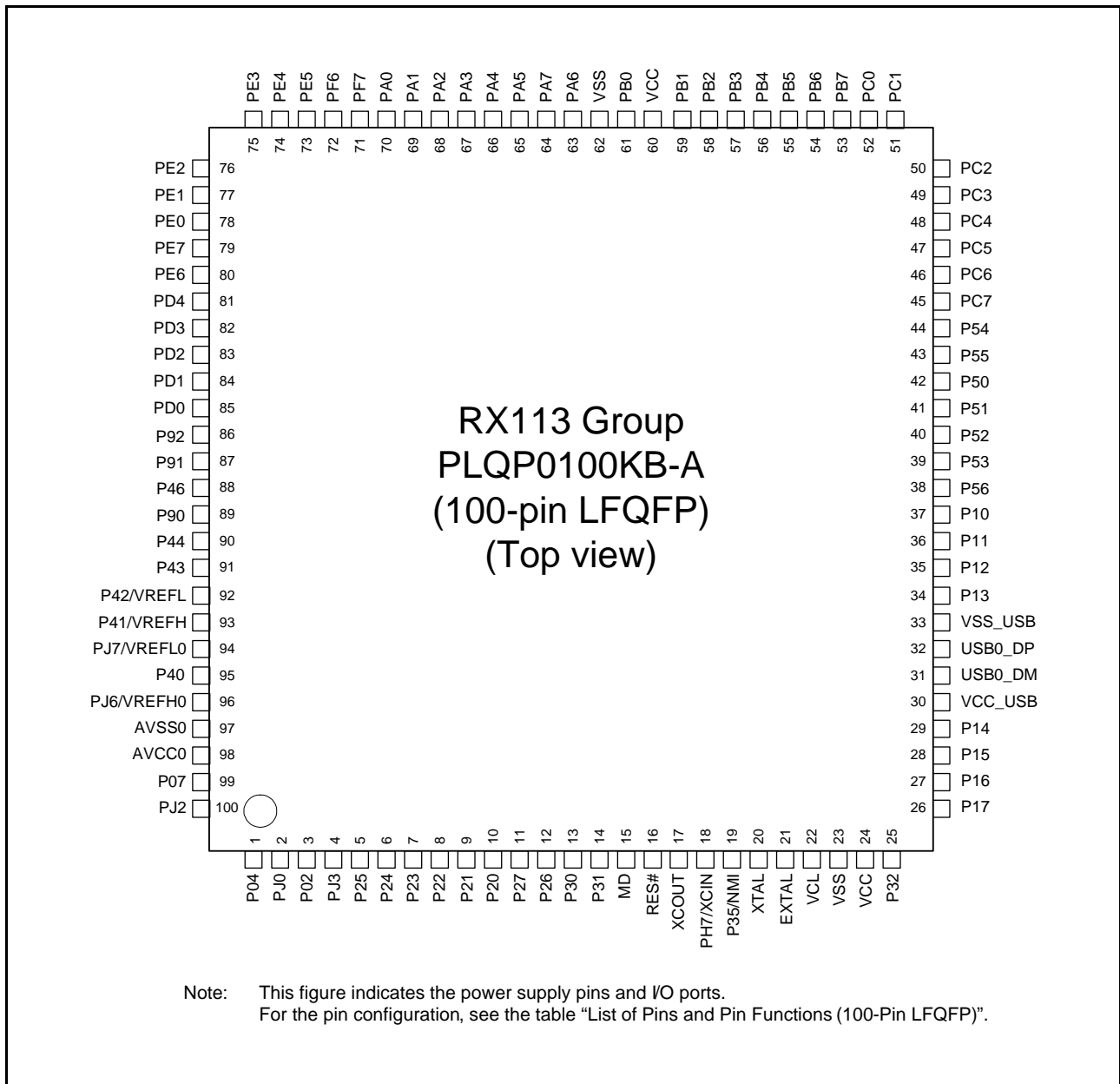


Figure 1.3 Pin Assignments of the 100-Pin LFQFP

Table 1.5 List of Pins and Pin Functions (100-Pin LQFP) (1/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC, TMR)	Communication (SCIE, SCIf, RSPI, RIIC, USB, SSI)	LCD, Touch	Others
1		P04	MTIOC0A/POE2#/TMC13	SCK6	TS1	
2		PJ0				DA0
3		P02	MTIOC0D/POE3#/TMR13	RXD6/SMISO6/SSCL6	TS2	
4		PJ3	MTIOC3C	CTS6#/RTS6#/SS6#	TS3	
5		P25	MTIOC4C/MTCLKB		TS4	ADTRG0#
6		P24	MTIOC4A/MTCLKA/TMR11		TS5	
7		P23	MTIOC3D/MTCLKD	CTS0#/RTS0#/SS0#	TS6	
8		P22	MTIOC3B/MTCLKC/TMO0	SCK0	TS7	
9		P21	MTIOC1B/TMC10	RXD0/SMISO0/SSCL0	TS8	
10		P20	MTIOC1A/TMR10	TXD0/SMOSI0/SSDA0	TS9	
11		P27	MTIOC2B/TMC13	SCK12/SCK1/RXD6/SMISO6/SSCL6	TS10	IRQ3/ADTRG0#/CACREF/CMPA2
12		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/USB0_VBUSEN/TXD6/SMOSI6/SSDA6	TSCAP	
13		P30	MTIOC4B/POE8#/TMR13	RXD1/SMISO1/SSCL1	CAPH	IRQ0
14		P31	MTIOC4D/TMC12	CTS1#/RTS1#/SS1#	CAPL	IRQ1
15	MD					FINED
16	RES#					
17	XCOUT					
18	XCIN	PH7				
19	UPSEL	P35				NMI
20	XTAL					
21	EXTAL					
22	VCL					
23	VSS					
24	VDD					
25		P32	MTIOC0C/RTCOUT/TMO3	TXD6/SMOSI6/SSDA6/CTS6#/RTS6#/SS6#	TS11	IRQ2
26		P17	MTIOC0C/MTIOC3A/MTIOC3B/POE8#/TMO1	SCK1/MISOA/SDA0/RXD12/RXD12/SMISO12/SSCL12		IRQ7
27		P16	MTIOC3C/MTIOC3D/RTCOUT/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/SCL0/USB0_VBUS/USB0_VBUSEN/USB0_OVRCURB		IRQ6/ADTRG0#
28		P15	MTIOC0B/MTCLKB/TMC12	RXD1/SMISO1/SSCL1/RSPCKA		IRQ5/CLKOUT/CACREF
29	UB#	P14	MTIOC0A/MTIOC3A/MTCLKA/TMR12	CTS1#/RTS1#/SS1#/SSLA0/TXD12/TXD12/SIOX12/SMOSI12/SSDA12/USB0_OVRCURA		IRQ4
30	VCC_USB					
31				USB0_DM		
32				USB0_DP		
33	VSS_USB					
34		P13	MTIOC0B/TMO3	CTS12#/RTS12#/SS12#/CTS0#/RTS0#/SS0#	SEG00	IRQ3
35		P12	TMC11	SCK12/SCK0	SEG01	IRQ2

Table 1.6 List of Pins and Pin Functions (100-Pin TFLGA) (3/3)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, POE, RTC, TMR)	Communication (SCIE, SCIf, RSPI, RIIC, USB, SSI)	LCD, Touch	Others
H1	XTAL					
H2	EXTAL					
H3		P15	MTIOC0B/MTCLKB/TMCI2	RXD1/SMISO1/SSCL1/RSPCKA		IRQ5/CLKOUT/CACREF
H4		P13	MTIOC0B/TMO3	CTS12#/RTS12#/SS12#/CTS0#/RTS0#/SS0#	SEG00	IRQ3
H5		P11	MTIC5U/POE0#	RXD12/RDX12/SMISO12/SSCL12/RXD0/SMISO0/SSCL0	SEG02	IRQ7
H6		P51	MTIOC4C	RSPCKA/SCK2	SEG07	
H7		PC0	MTIOC3C	CTS5#/RTS5#/SS5#/SSLA1	SEG10	
H8		PC1	MTIOC3A	SCK5/SSLA2	SEG09	
H9		PB6	MTIOC3D	RXD9/SMISO9/SSCL9/SSIRXD0	SEG12/COM5	
H10		PB7	MTIOC3B	TXD9/SMOSI9/SSDA9/SSITXD0	SEG11/COM4	
J1	VCL					
J2		P17	MTIOC0C/MTIOC3A/MTIOC3B/POE8#/TMO1	SCK1/MISOA/SDA0/RXD12/RDX12/SMISO12/SSCL12		IRQ7
J3		P32	MTIOC0C/RTCOU/ TMO3	TXD6/SMOSI6/SSDA6/CTS6#/RTS6#/SS6#	TS11	IRQ2
J4	VCC_USB					
J5	VSS_USB					
J6		P52		MISOA/RXD2/SMISO2/SSCL2	SEG06	
J7		P55	MTIOC4D/TMO3		VL1	
J8		PC7	MTIOC3A/MTCLKB/TMO2	TXD1/SMOSI1/SSDA1/MISOA/ TXD8/SMOSI8/SSDA8/ USB0_OVRCURB	VL3	CACREF
J9		PC4	MTIOC3D/MTCLKC/ POE0#/TMCI1	SSLA0/CTS8#/RTS8#/SS8#/SCK5/ USB0_VBUSEN/USB0_VBUS *1	COM1	IRQ2/CLKOUT
J10		PC2	MTIOC4B	RXD5/SMOSI5/SSCL5/IRRXD5/SSLA3	COM3	
K1	VSS					
K2	VDD					
K3		P16	MTIOC3C/MTIOC3D/ RTCOU/TMO2	TXD1/SMOSI1/SSDA1/MOSIA/ SCL0/USB0_VBUS/ USB0_VBUSEN/USB0_OVRCURB		IRQ6/ADTRG0#
K4				USB0_DM		
K5				USB0_DP		
K6		P53	MTIOC2B	SSLA0/CTS2#/RTS2#/SS2#	SEG05	
K7		P54	MTIOC4B/TMCI1		VL2	
K8		PC6	MTIOC3C/MTCLKA/ TMCI2	RXD1/SMISO1/SSCL1/MOSIA/ RXD8/SMISO8/SSCL8/ USB0_EXICEN	VL4	
K9		PC5	MTIOC3B/MTCLKD/ TMRI2	SCK1/RSPCKA/SCK8/USB0_ID	COM0	
K10		PC3	MTIOC4D	TXD5/SMOSI5/SSDA5/IRTXD5	COM2	

Note 1. Not 5 V tolerant.

Note 2. The power source of the I/O buffer for these pins is AVCC0.

4. I/O Registers

This section provides information on the on-chip I/O register addresses and bit configuration. The information is given as shown below. Notes on writing to I/O registers are also given below.

(1) I/O register addresses (address order)

- Registers are listed from the lower allocation addresses.
- Registers are classified according to module symbols.
- Numbers of cycles for access indicate numbers of cycles of the given base clock.
- Among the internal I/O register area, addresses not listed in the list of registers are reserved. Reserved addresses must not be accessed. Do not access these addresses; otherwise, the operation when accessing these bits and subsequent operations cannot be guaranteed.

(2) Notes on writing to I/O registers

While writing to an I/O register, the CPU starts executing subsequent instructions before the I/O register write access is completed. This may cause the subsequent instructions to be executed before the write value is reflected in the operation. The examples below show how subsequent instructions must be executed after a write access to an I/O register is completed.

[Examples of cases requiring special care]

- The subsequent instruction must be executed while an interrupt request is disabled with the IENj bit in IERn of the ICU (interrupt request enable bit) set to 0.
- A WAIT instruction is executed immediately after the preprocessing for causing a transition to the low power consumption state.

In the above cases, after writing to an I/O register, wait until the write operation is completed using the following procedure and then execute the subsequent instruction.

- Write to an I/O register.
- Read the value in the I/O register and write it to a general register.
- Execute the operation using the value read.
- Execute the subsequent instruction.

Example of instructions

- Byte-size I/O registers

```
MOV.L #SFR_ADDR, R1
MOV.B #SFR_DATA, [R1]
CMP [R1].UB, R1
;; Next process
```

- Word-size I/O registers

```
MOV.L #SFR_ADDR, R1
MOV.W #SFR_DATA, [R1]
CMP [R1].W, R1
;; Next process
```

Table 4.1 List of I/O Registers (Address Order) (9/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 8304h	RIIC0	I ² C Bus Mode Register 3	ICMR3	8	8	2 or 3 PCLKB
0008 8305h	RIIC0	I ² C Bus Function Enable Register	ICFER	8	8	2 or 3 PCLKB
0008 8306h	RIIC0	I ² C Bus Status Enable Register	ICSER	8	8	2 or 3 PCLKB
0008 8307h	RIIC0	I ² C Bus Interrupt Enable Register	ICIER	8	8	2 or 3 PCLKB
0008 8308h	RIIC0	I ² C Bus Status Register 1	ICSR1	8	8	2 or 3 PCLKB
0008 8309h	RIIC0	I ² C Bus Status Register 2	ICSR2	8	8	2 or 3 PCLKB
0008 830Ah	RIIC0	Slave Address Register L0	SARL0	8	8	2 or 3 PCLKB
0008 830Ah	RIIC0	Timeout Internal Counter L	TMOCNL	8	8	2 or 3 PCLKB
0008 830Bh	RIIC0	Slave Address Register U0	SARU0	8	8	2 or 3 PCLKB
0008 830Bh	RIIC0	Timeout Internal Counter U	TMOCNTU	8	8 *2	2 or 3 PCLKB
0008 830Ch	RIIC0	Slave Address Register L1	SARL1	8	8	2 or 3 PCLKB
0008 830Dh	RIIC0	Slave Address Register U1	SARU1	8	8	2 or 3 PCLKB
0008 830Eh	RIIC0	Slave Address Register L2	SARL2	8	8	2 or 3 PCLKB
0008 830Fh	RIIC0	Slave Address Register U2	SARU2	8	8	2 or 3 PCLKB
0008 8310h	RIIC0	I ² C Bus Bit Rate Low-Level Register	ICBRL	8	8	2 or 3 PCLKB
0008 8311h	RIIC0	I ² C Bus Bit Rate High-Level Register	ICBRH	8	8	2 or 3 PCLKB
0008 8312h	RIIC0	I ² C Bus Transmit Data Register	ICDRT	8	8	2 or 3 PCLKB
0008 8313h	RIIC0	I ² C Bus Receive Data Register	ICDRR	8	8	2 or 3 PCLKB
0008 8380h	RSPI0	RSPI Control Register	SPCR	8	8	2 or 3 PCLKB
0008 8381h	RSPI0	RSPI Slave Select Polarity Register	SSLP	8	8	2 or 3 PCLKB
0008 8382h	RSPI0	RSPI Pin Control Register	SPPCR	8	8	2 or 3 PCLKB
0008 8383h	RSPI0	RSPI Status Register	SPSR	8	8	2 or 3 PCLKB
0008 8384h	RSPI0	RSPI Data Register	SPDR	32	16, 32	2 or 3 PCLKB/2ICLK
0008 8388h	RSPI0	RSPI Sequence Control Register	SPSCR	8	8	2 or 3 PCLKB
0008 8389h	RSPI0	RSPI Sequence Status Register	SPSSR	8	8	2 or 3 PCLKB
0008 838Ah	RSPI0	RSPI Bit Rate Register	SPBR	8	8	2 or 3 PCLKB
0008 838Bh	RSPI0	RSPI Data Control Register	SPDCR	8	8	2 or 3 PCLKB
0008 838Ch	RSPI0	RSPI Clock Delay Register	SPCKD	8	8	2 or 3 PCLKB
0008 838Dh	RSPI0	RSPI Slave Select Negation Delay Register	SSLND	8	8	2 or 3 PCLKB
0008 838Eh	RSPI0	RSPI Next-Access Delay Register	SPND	8	8	2 or 3 PCLKB
0008 838Fh	RSPI0	RSPI Control Register 2	SPCR2	8	8	2 or 3 PCLKB
0008 8390h	RSPI0	RSPI Command Register 0	SPCMD0	16	16	2 or 3 PCLKB
0008 8392h	RSPI0	RSPI Command Register 1	SPCMD1	16	16	2 or 3 PCLKB
0008 8394h	RSPI0	RSPI Command Register 2	SPCMD2	16	16	2 or 3 PCLKB
0008 8396h	RSPI0	RSPI Command Register 3	SPCMD3	16	16	2 or 3 PCLKB
0008 8398h	RSPI0	RSPI Command Register 4	SPCMD4	16	16	2 or 3 PCLKB
0008 839Ah	RSPI0	RSPI Command Register 5	SPCMD5	16	16	2 or 3 PCLKB
0008 839Ch	RSPI0	RSPI Command Register 6	SPCMD6	16	16	2 or 3 PCLKB
0008 839Eh	RSPI0	RSPI Command Register 7	SPCMD7	16	16	2 or 3 PCLKB
0008 8410h	IRDA	IrDA Control Register	IRCR	8	8	2 or 3 PCLKB
0008 8600h	MTU3	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8601h	MTU4	Timer Control Register	TCR	8	8	2 or 3 PCLKB
0008 8602h	MTU3	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8603h	MTU4	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB
0008 8604h	MTU3	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8605h	MTU3	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8606h	MTU4	Timer I/O Control Register H	TIORH	8	8	2 or 3 PCLKB
0008 8607h	MTU4	Timer I/O Control Register L	TIORL	8	8	2 or 3 PCLKB
0008 8608h	MTU3	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 8609h	MTU4	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB
0008 860Ah	MTU	Timer Output Master Enable Register	TOER	8	8	2 or 3 PCLKB
0008 860Dh	MTU	Timer Gate Control Register	TGCR	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (12/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 9016h	S12AD	A/D Channel Select Register B1	ADANSB1	16	16	2 or 3 PCLKB
0008 9018h	S12AD	A/D Data Duplication Register	ADDBLDR	16	16	2 or 3 PCLKB
0008 901Ah	S12AD	A/D Temperature Sensor Data Register	ADTSDR	16	16	2 or 3 PCLKB
0008 901Ch	S12AD	A/D Internal Reference Voltage Data Register	ADOCDR	16	16	2 or 3 PCLKB
0008 9020h	S12AD	A/D Data Register 0	ADDR0	16	16	2 or 3 PCLKB
0008 9022h	S12AD	A/D Data Register 1	ADDR1	16	16	2 or 3 PCLKB
0008 9024h	S12AD	A/D Data Register 2	ADDR2	16	16	2 or 3 PCLKB
0008 9026h	S12AD	A/D Data Register 3	ADDR3	16	16	2 or 3 PCLKB
0008 9028h	S12AD	A/D Data Register 4	ADDR4	16	16	2 or 3 PCLKB
0008 902Ah	S12AD	A/D Data Register 5	ADDR5	16	16	2 or 3 PCLKB
0008 902Ch	S12AD	A/D Data Register 6	ADDR6	16	16	2 or 3 PCLKB
0008 902Eh	S12AD	A/D Data Register 7	ADDR7	16	16	2 or 3 PCLKB
0008 9030h	S12AD	A/D Data Register 8	ADDR8	16	16	2 or 3 PCLKB
0008 9032h	S12AD	A/D Data Register 9	ADDR9	16	16	2 or 3 PCLKB
0008 9034h	S12AD	A/D Data Register 10	ADDR10	16	16	2 or 3 PCLKB
0008 9036h	S12AD	A/D Data Register 11	ADDR11	16	16	2 or 3 PCLKB
0008 9038h	S12AD	A/D Data Register 12	ADDR12	16	16	2 or 3 PCLKB
0008 903Ah	S12AD	A/D Data Register 13	ADDR13	16	16	2 or 3 PCLKB
0008 903Ch	S12AD	A/D Data Register 14	ADDR14	16	16	2 or 3 PCLKB
0008 903Eh	S12AD	A/D Data Register 15	ADDR15	16	16	2 or 3 PCLKB
0008 904Ah	S12AD	A/D Data Register 21	ADDR21	16	16	2 or 3 PCLKB
0008 9060h	S12AD	A/D Sampling State Register 0	ADSSTR0	8	8	2 or 3 PCLKB
0008 9061h	S12AD	A/D Sampling State Register L	ADSSTRL	8	8	2 or 3 PCLKB
0008 9070h	S12AD	A/D Sampling State Register T	ADSSTRT	8	8	2 or 3 PCLKB
0008 9071h	S12AD	A/D Sampling State Register O	ADSSTRO	8	8	2 or 3 PCLKB
0008 9073h	S12AD	A/D Sampling State Register 1	ADSSTR1	8	8	2 or 3 PCLKB
0008 9074h	S12AD	A/D Sampling State Register 2	ADSSTR2	8	8	2 or 3 PCLKB
0008 9075h	S12AD	A/D Sampling State Register 3	ADSSTR3	8	8	2 or 3 PCLKB
0008 9076h	S12AD	A/D Sampling State Register 4	ADSSTR4	8	8	2 or 3 PCLKB
0008 9077h	S12AD	A/D Sampling State Register 5	ADSSTR5	8	8	2 or 3 PCLKB
0008 9078h	S12AD	A/D Sampling State Register 6	ADSSTR6	8	8	2 or 3 PCLKB
0008 9079h	S12AD	A/D Sampling State Register 7	ADSSTR7	8	8	2 or 3 PCLKB
0008 907Ch	S12AD	A/D High-Side Reference Voltage Control Register	ADHVREFCNT	8	8	2 or 3 PCLKB
0008 9080h	S12AD	A/D Sampling State Register 21	ADSSTR21	8	8	2 or 3 PCLKB
0008 A000h	SCI0	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A001h	SCI0	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A002h	SCI0	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A003h	SCI0	Transmit Data Register	TDR	8	8	2 or 3 PCLKB
0008 A004h	SCI0	Serial Status Register	SSR	8	8	2 or 3 PCLKB
0008 A005h	SCI0	Receive Data Register	RDR	8	8	2 or 3 PCLKB
0008 A006h	SCI0	Smart Card Mode Register	SCMR	8	8	2 or 3 PCLKB
0008 A007h	SCI0	Serial Extended Mode Register	SEMR	8	8	2 or 3 PCLKB
0008 A008h	SCI0	Noise Filter Setting Register	SNFR	8	8	2 or 3 PCLKB
0008 A009h	SCI0	I ² C Mode Register 1	SIMR1	8	8	2 or 3 PCLKB
0008 A00Ah	SCI0	I ² C Mode Register 2	SIMR2	8	8	2 or 3 PCLKB
0008 A00Bh	SCI0	I ² C Mode Register 3	SIMR3	8	8	2 or 3 PCLKB
0008 A00Ch	SCI0	I ² C Status Register	SISR	8	8	2 or 3 PCLKB
0008 A00Dh	SCI0	SPI Mode Register	SPMR	8	8	2 or 3 PCLKB
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2 or 3 PCLKB
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2 or 3 PCLKB
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2 or 3 PCLKB
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2 or 3 PCLKB

Table 4.1 List of I/O Registers (Address Order) (20/23)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States
0008 C402h	RTC	Binary Counter 0	BCNT0	8	8	2 or 3 PCLKB
0008 C404h	RTC	Minute Counter	RMINCNT	8	8	2 or 3 PCLKB
0008 C404h	RTC	Binary Counter 1	BCNT1	8	8	2 or 3 PCLKB
0008 C406h	RTC	Hour Counter	RHRCNT	8	8	2 or 3 PCLKB
0008 C406h	RTC	Binary Counter 2	BCNT2	8	8	2 or 3 PCLKB
0008 C408h	RTC	Day-Of-Week Counter	RWKCNT	8	8	2 or 3 PCLKB
0008 C408h	RTC	Binary Counter 3	BCNT3	8	8	2 or 3 PCLKB
0008 C40Ah	RTC	Date Counter	RDAYCNT	8	8	2 or 3 PCLKB
0008 C40Ch	RTC	Month Counter	RMONCNT	8	8	2 or 3 PCLKB
0008 C40Eh	RTC	Year Counter	RYRCNT	16	16	2 or 3 PCLKB
0008 C410h	RTC	Second Alarm Register	RSECAR	8	8	2 or 3 PCLKB
0008 C410h	RTC	Binary Counter 0 Alarm Register	BCNT0AR	8	8	2 or 3 PCLKB
0008 C412h	RTC	Minute Alarm Register	RMINAR	8	8	2 or 3 PCLKB
0008 C412h	RTC	Binary Counter 1 Alarm Register	BCNT1AR	8	8	2 or 3 PCLKB
0008 C414h	RTC	Hour Alarm Register	RHRAR	8	8	2 or 3 PCLKB
0008 C414h	RTC	Binary Counter 2 Alarm Register	BCNT2AR	8	8	2 or 3 PCLKB
0008 C416h	RTC	Day-of-Week Alarm Register	RWKAR	8	8	2 or 3 PCLKB
0008 C416h	RTC	Binary Counter 3 Alarm Register	BCNT3AR	8	8	2 or 3 PCLKB
0008 C418h	RTC	Date Alarm Register	RDAYAR	8	8	2 or 3 PCLKB
0008 C418h	RTC	Binary Counter 0 Alarm Enable Register	BCNT0AER	8	8	2 or 3 PCLKB
0008 C41Ah	RTC	Month Alarm Register	RMONAR	8	8	2 or 3 PCLKB
0008 C41Ah	RTC	Binary Counter 1 Alarm Enable Register	BCNT1AER	8	8	2 or 3 PCLKB
0008 C41Ch	RTC	Year Alarm Register	RYRAR	16	16	2 or 3 PCLKB
0008 C41Ch	RTC	Binary Counter 2 Alarm Enable Register	BCNT2AER	16	16	2 or 3 PCLKB
0008 C41Eh	RTC	Year Alarm Enable Register	RYRAREN	8	8	2 or 3 PCLKB
0008 C41Eh	RTC	Binary Counter 3 Alarm Enable Register	BCNT3AER	8	8	2 or 3 PCLKB
0008 C422h	RTC	RTC Control Register 1	RCR1	8	8	2 or 3 PCLKB
0008 C424h	RTC	RTC Control Register 2	RCR2	8	8	2 or 3 PCLKB
0008 C426h	RTC	RTC Control Register 3	RCR3	8	8	2 or 3 PCLKB
0008 C42Eh	RTC	Time Error Adjustment Register	RADJ	8	8	2 or 3 PCLKB
0008 C580h	CMPB	Comparator B Control Register 1	CPBCNT1	8	8	2 or 3 PCLKB
0008 C581h	CMPB	Comparator B Control Register 2	CPBCNT2	8	8	2 or 3 PCLKB
0008 C582h	CMPB	Comparator B Flag Register	CPBFLG	8	8	2 or 3 PCLKB
0008 C583h	CMPB	Comparator B Interrupt Control Register	CPBINT	8	8	2 or 3 PCLKB
0008 C584h	CMPB	Comparator B Filter Select Register	CPBF	8	8	2 or 3 PCLKB
0008 C585h	CMPB	Comparator B Mode Select Register	CPBMD	8	8	2 or 3 PCLKB
0008 C586h	CMPB	Comparator B Reference Input Voltage Select Register	CPBREF	8	8	2 or 3 PCLKB
0008 C587h	CMPB	Comparator B Output Control Register	CPBOCR	8	8	2 or 3 PCLKB
000A 0000h	USB0	System Configuration Control Register	SYSCFG	16	16	3 or 4 PCLKB
000A 0004h	USB0	System Configuration Status Register 0	SYSSTS0	16	16	9 PCLK or more
000A 0008h	USB0	Device State Control Register 0	DVSTCTR0	16	16	9 PCLK or more
000A 0014h	USB0	CFIFO Port Register	CFIFO	16	16	3 or 4 PCLKB
000A 0018h	USB0	D0FIFO Port Register	D0FIFO	16	16	3 or 4 PCLKB
000A 001Ch	USB0	D1FIFO Port Register	D1FIFO	16	16	3 or 4 PCLKB
000A 0020h	USB0	CFIFO Port Select Register	CFIFOSEL	16	16	3 or 4 PCLKB
000A 0028h	USB0	D0FIFO Port Select Register	D0FIFOSEL	16	16	3 or 4 PCLKB
000A 002Ch	USB0	D1FIFO Port Select Register	D1FIFOSEL	16	16	3 or 4 PCLKB
000A 0022h	USB0	CFIFO Port Control Register	CFIFOCTR	16	16	3 or 4 PCLKB
000A 002Ah	USB0	D0FIFO Port Control Register	D0FIFOCTR	16	16	3 or 4 PCLKB
000A 002Eh	USB0	D1FIFO Port Control Register	D1FIFOCTR	16	16	3 or 4 PCLKB
000A 0030h	USB0	Interrupt Enable Register 0	INTENB0	16	16	9 PCLKB or more
000A 0032h	USB0	Interrupt Enable Register 1	INTENB1	16	16	9 PCLKB or more

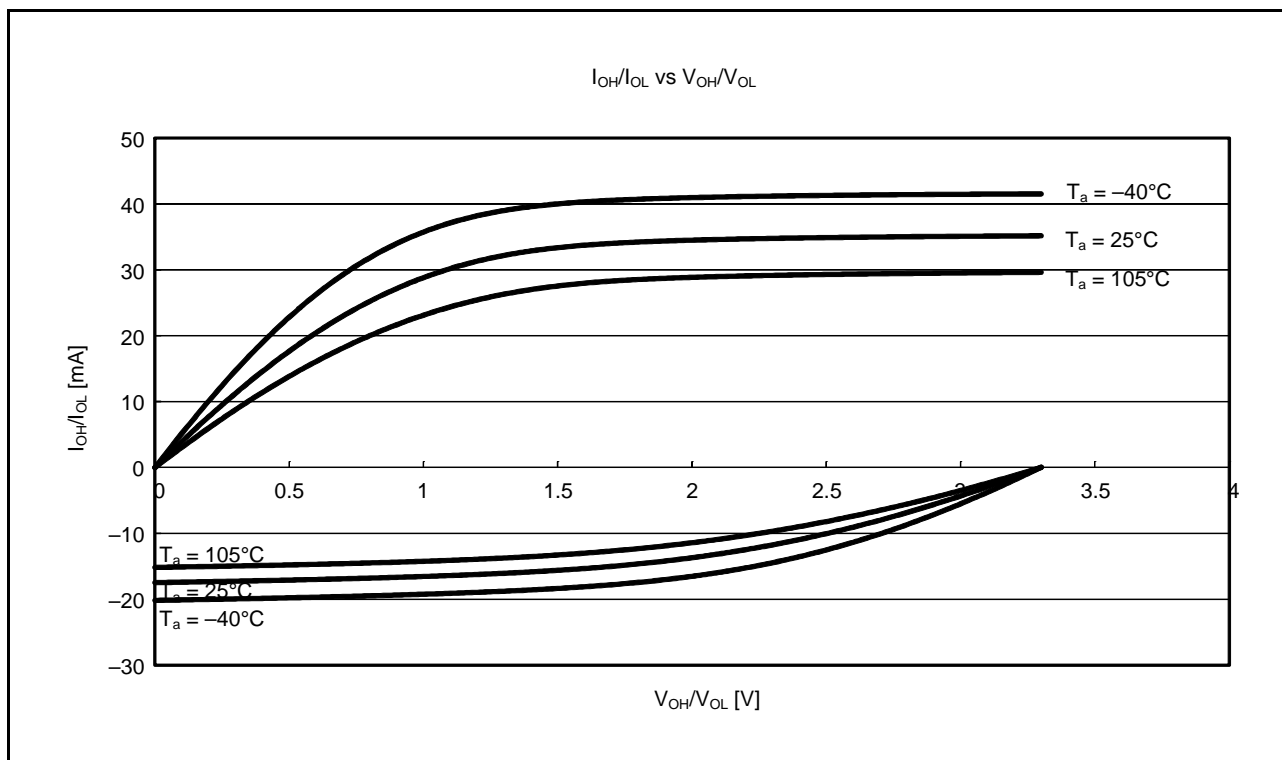


Figure 5.10 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics of General Ports (Except for RIIC Output Pin, Ports P40 to P44, P46, Ports P90 to P92, Ports PJ6, PJ7) at $V_{CC} = 3.3\text{ V}$ (Reference Data)

5.2.2 Standard I/O Pin Output Characteristics (2)

Figure 5.11 to Figure 5.13 show the characteristics of the RIIC output pin.

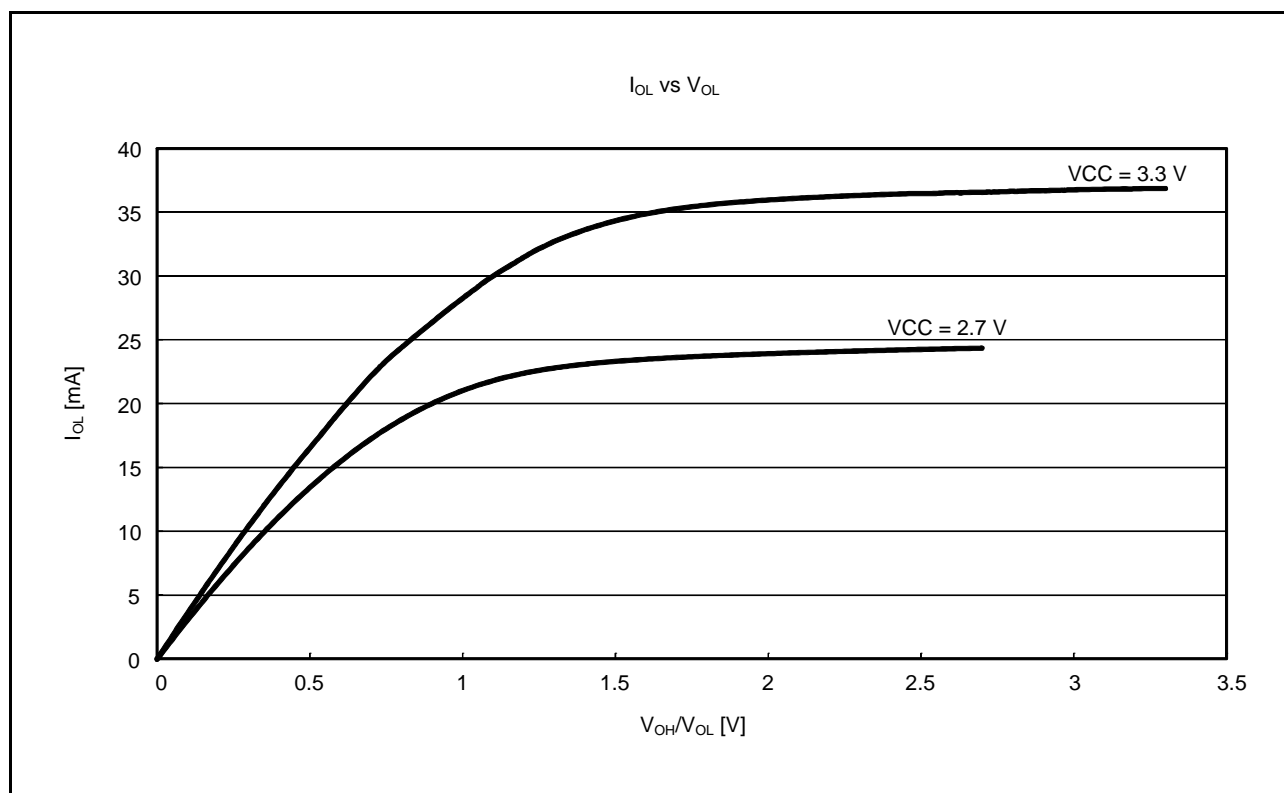


Figure 5.11 V_{OL} and I_{OL} Voltage Characteristics of RIIC Output Pin at $T_a = 25^\circ\text{C}$ (Reference Data)

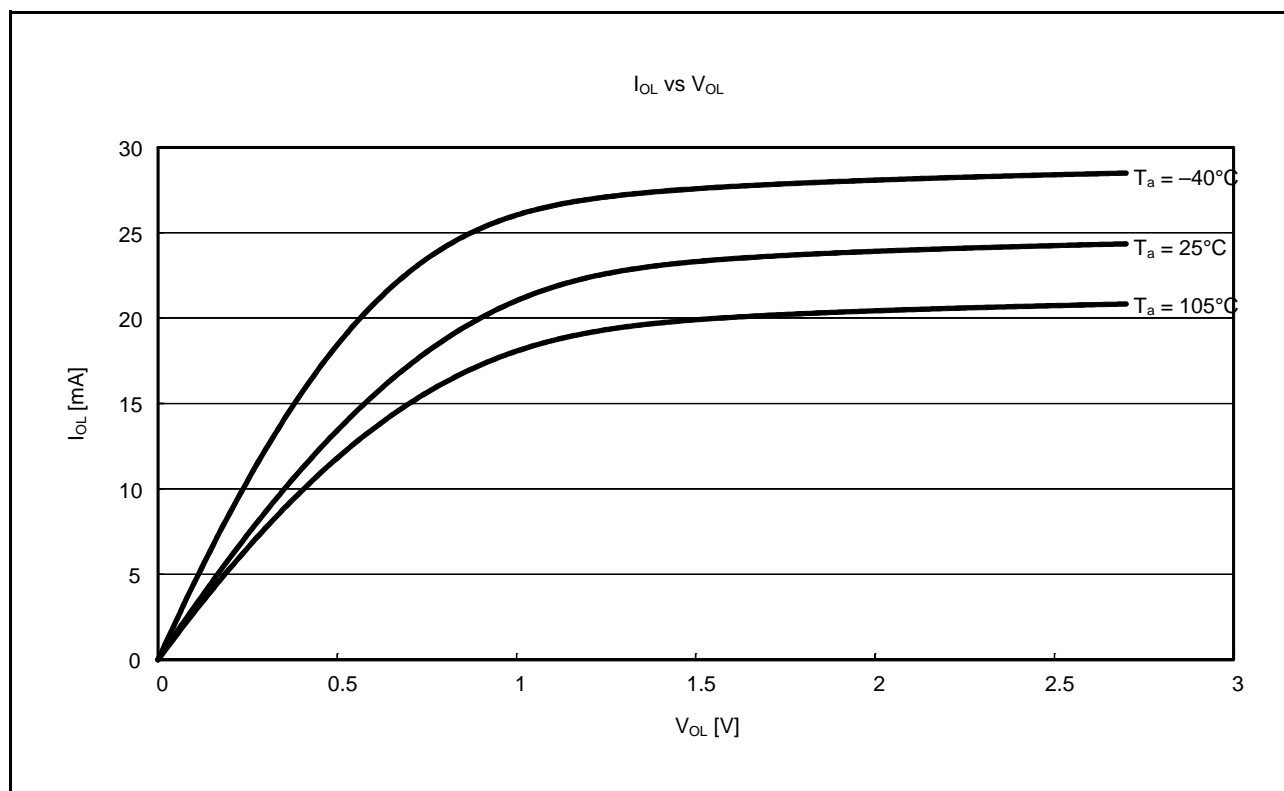


Figure 5.12 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at $V_{CC} = 2.7\text{ V}$ (Reference Data)

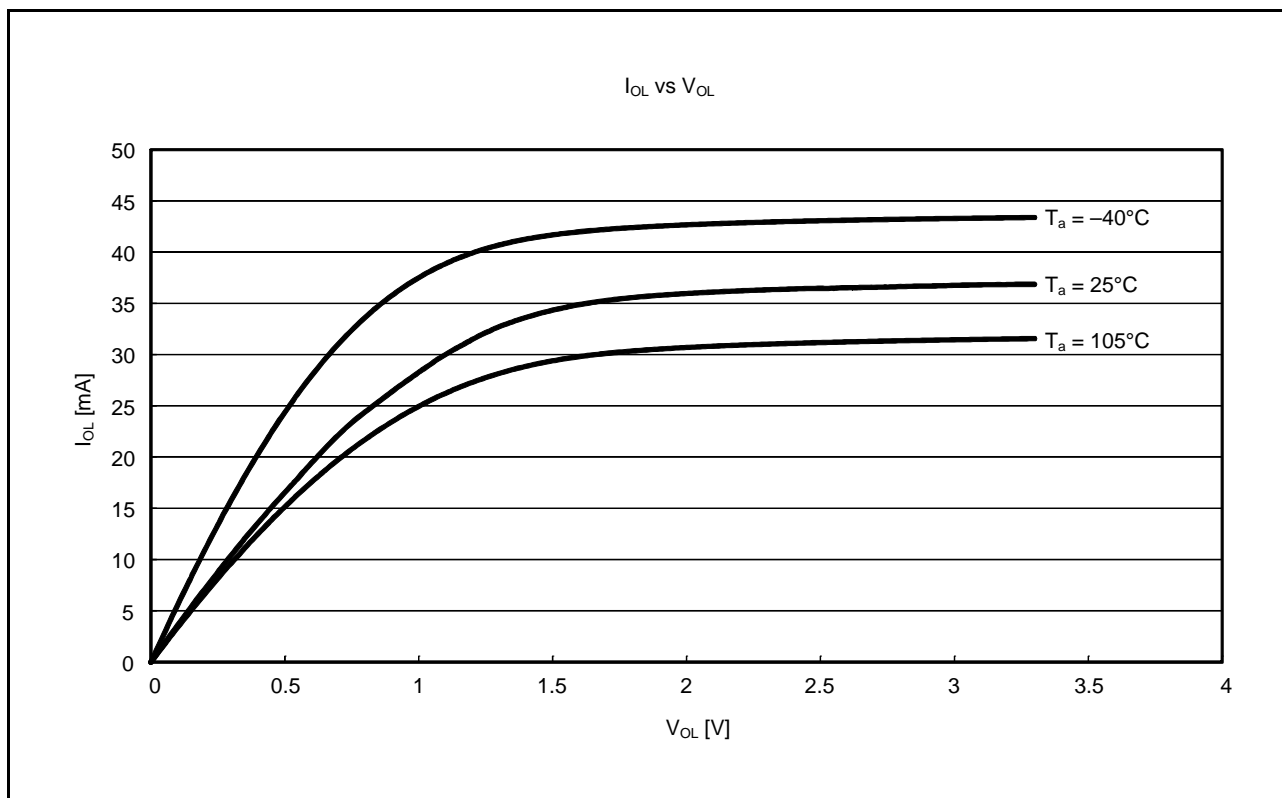


Figure 5.13 V_{OL} and I_{OL} Temperature Characteristics of RIIC Output Pin at VCC = 3.3 V (Reference Data)

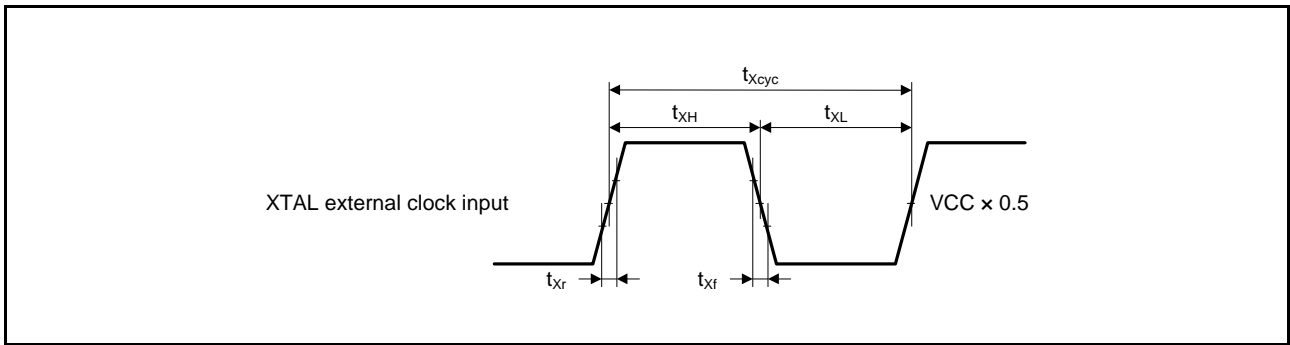


Figure 5.18 XTAL External Clock Input Timing

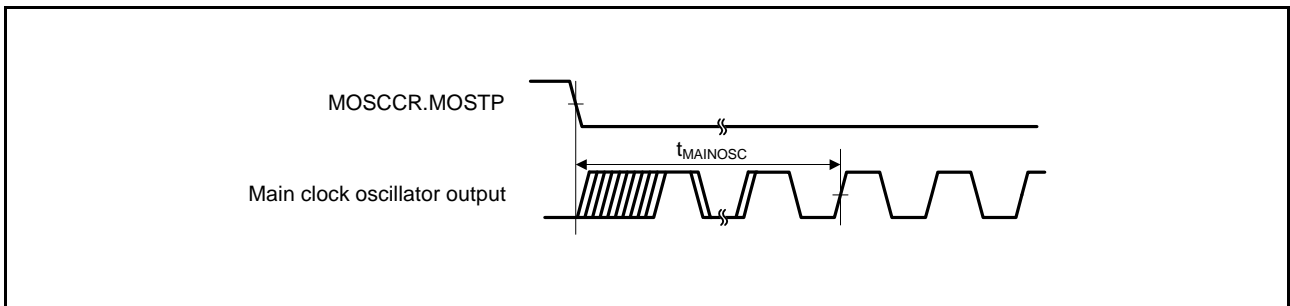


Figure 5.19 Main Clock Oscillation Start Timing

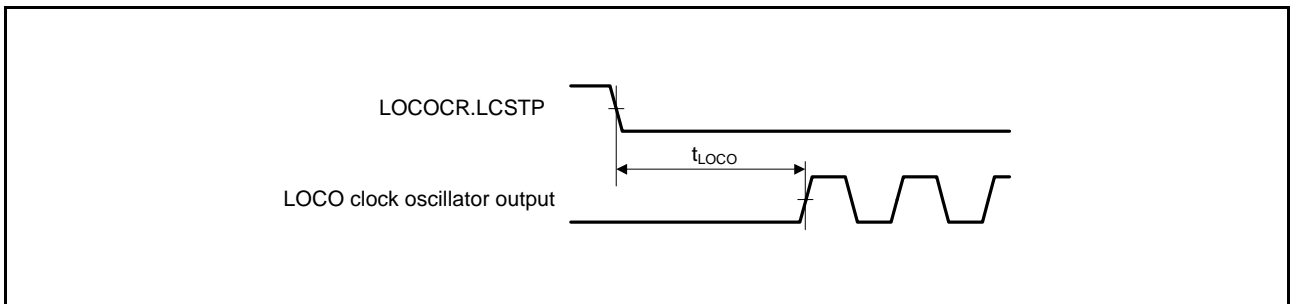


Figure 5.20 LOCO Clock Oscillation Start Timing

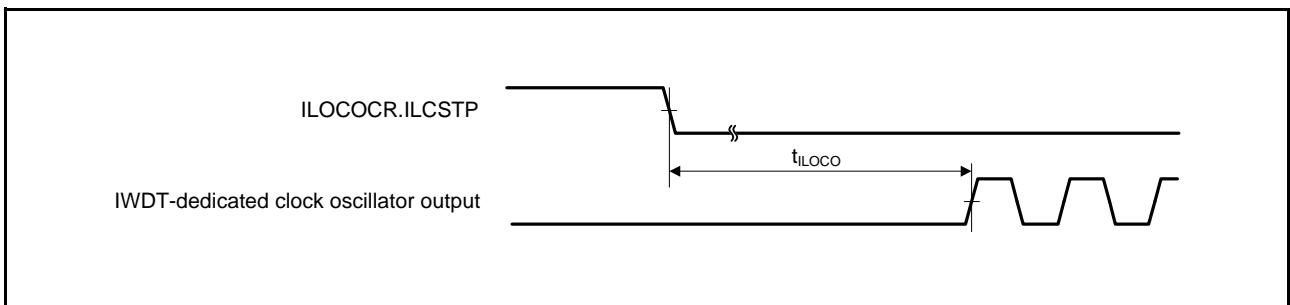


Figure 5.21 IWDT-Dedicated Clock Oscillation Start Timing

Note 6. When the frequency of HOCO is 8 MHz.
 When the high-speed clock oscillator wait control register (HOCOWTCR) is set to 05h.

Table 5.26 Timing of Recovery from Low Power Consumption Modes (3)

Conditions: $1.8\text{ V} \leq VCC = VCC_USB \leq 3.6\text{ V}$, $1.8\text{ V} \leq AVCC0 \leq 3.6\text{ V}$, $VSS = AVSS0 = VSS_USB = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Recovery time from software standby mode*1	Low-speed mode Sub-clock oscillator operating	t_{SBYSC}	—	600	750	μs	Figure 5.29

Note: When the division ratios of PCLKB, PCLKD, FCLK, and ICLK are all set to 1.

Note 1. The sub-clock continues oscillating in software standby mode during low-speed mode.

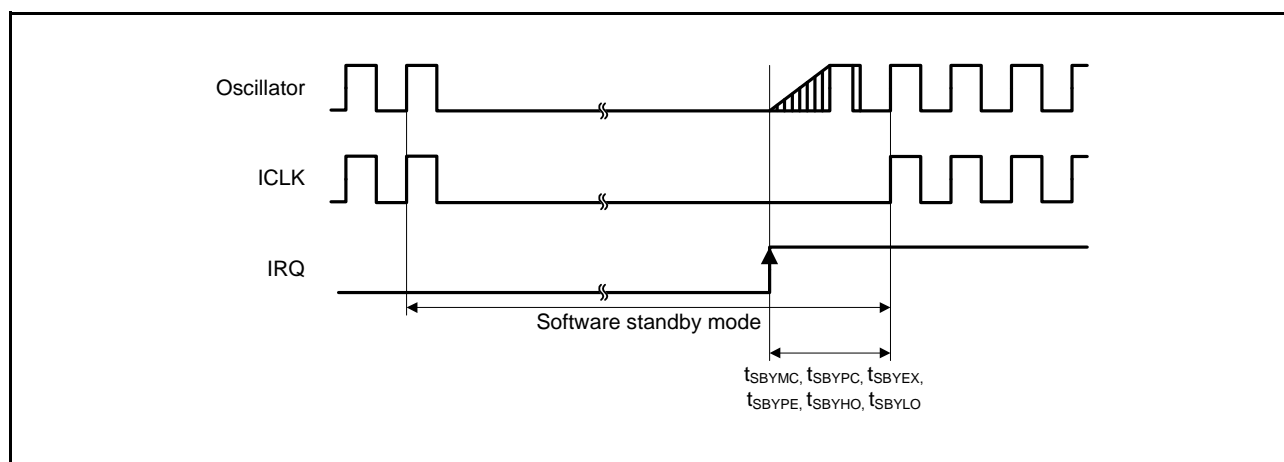


Figure 5.29 Software Standby Mode Recovery Timing

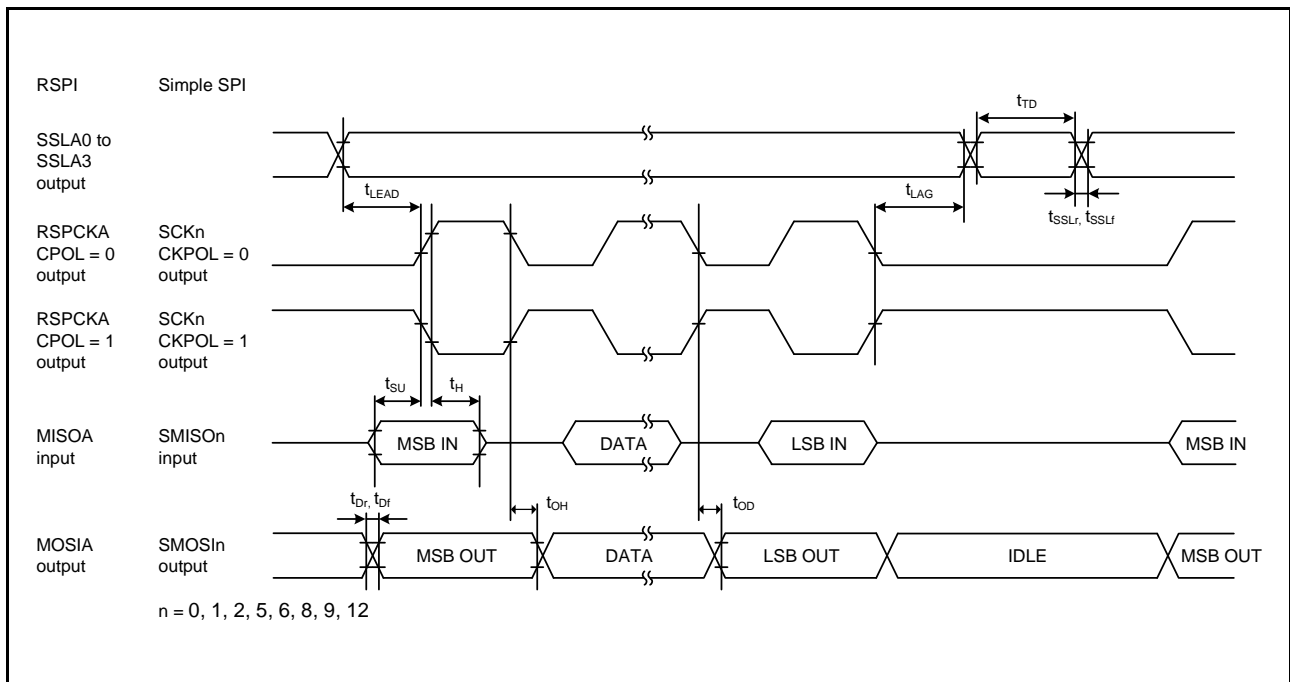


Figure 5.43 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Division Ratio Other Than Divided by 2) and Simple SPI Timing (Master, CKPH = 1)

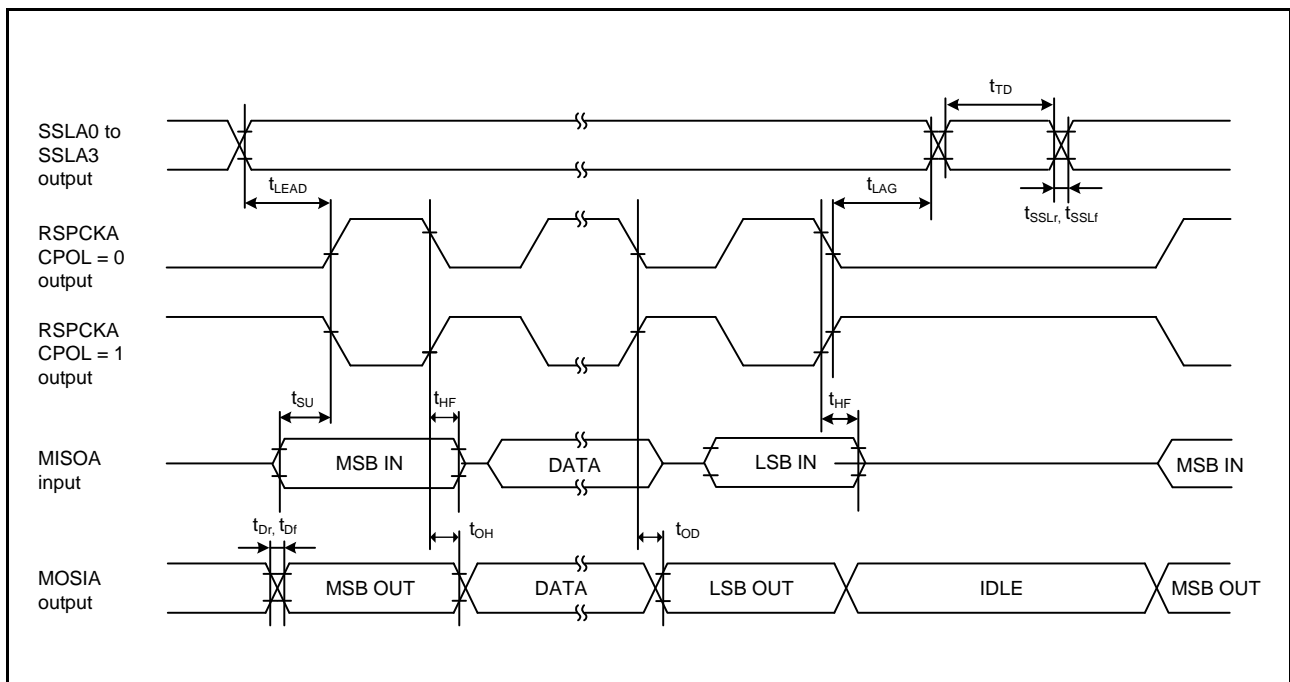


Figure 5.44 RSPI Timing (Master, CPHA = 0) (Bit Rate: PCLKB Set to Divided by 2)

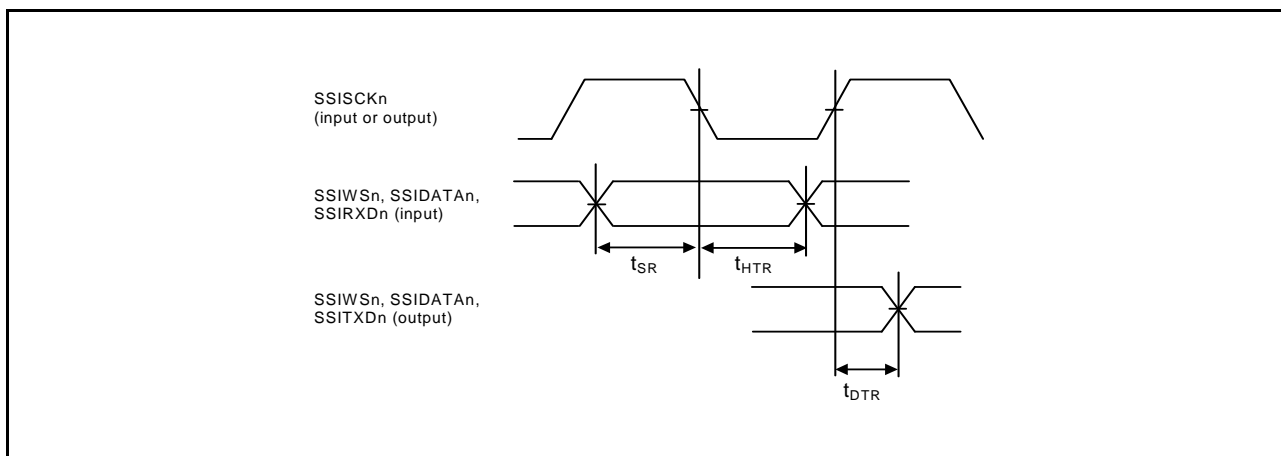


Figure 5.52 Transmission/Reception Timing (Synchronized with SSISCKn Falling Edge)

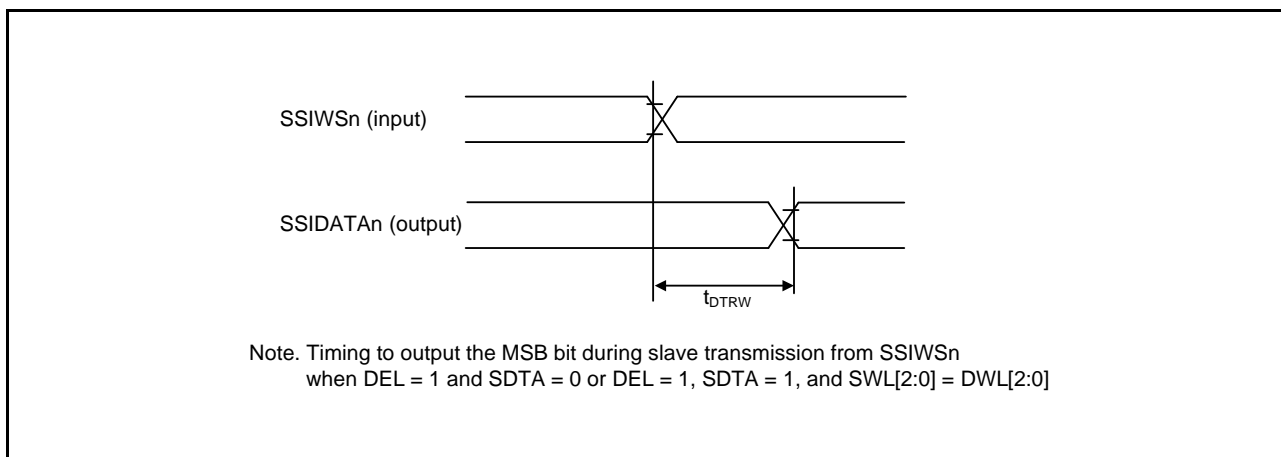


Figure 5.53 SSIDATA Output Delay After SSIWSn Changing Edge

5.4 USB Characteristics

Table 5.36 USB Characteristics (USB0_DP and USB0_DM Pin Characteristics)

Conditions: $3.0\text{ V} \leq VCC = VCC_USB \leq 3.6\text{ V}$, $3.0\text{ V} \leq AVCC0 \leq 3.6\text{ V}$, $VSS = AVSS0 = VSS_USB = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Symbol	Min.	Max.	Unit	Test Conditions	
Input characteristics	Input high level voltage	V_{IH}	2.0	—	V		
	Input low level voltage	V_{IL}	—	0.8	V		
	Differential input sensitivity	V_{DI}	0.2	—	V	$ \text{USB0_DP} - \text{USB0_DM} $	
	Differential common mode range	V_{CM}	0.8	2.5	V		
Output characteristics	Output high level voltage	V_{OH}	2.8	VCC_USB	V	$I_{OH} = -200\ \mu\text{A}$	
	Output low level voltage	V_{OL}	0.0	0.3	V	$I_{OL} = 2\ \text{mA}$	
	Cross-over voltage	V_{CRS}	1.3	2.0	V	Figure 5.54 Figure 5.55	
	Rise time	FS	t_r	4	20		ns
		LS		75	300		
	Fall time	FS	t_f	4	20		ns
		LS		75	300		
	Rise/fall time ratio	FS	t_r/t_f	90	111.11		%
		LS		80	125		
Output resistance		Z_{DRV}	28	44	Ω	(Adjusting the resistance of external elements is not necessary.)	
VBUS characteristics	VBUS input voltage	V_{IH}	$VCC \times 0.8$	—	V		
		V_{IL}	—	$VCC \times 0.2$	V		
	VBUS (P16) input leakage current	$ I_{VBUSIN} $	—	10	μA	$\text{USB0_VBUS} = 5.5\text{ V}$	
Pull-up, pull-down	Pull-down resistor	R_{PD}	14.25	24.80	$\text{k}\Omega$		
	Pull-up resistor	R_{PUJ}	0.9	1.575	$\text{k}\Omega$	During idle state	
		R_{PUA}	1.425	3.09	$\text{k}\Omega$	During reception	
Battery Charging Specification Ver 1.2	USB0_DP sink current	I_{DP_SINK}	25	175	μA		
	USB0_DM sink current	I_{DM_SINK}	25	175	μA		
	DCD source current	I_{DP_SRC}	7	13	μA		
	Data detection voltage	V_{DAT_REF}	0.25	0.4	V		
	USB0_DP source current	V_{DP_SRC}	0.5	0.7	V	Output current = $250\ \mu\text{A}$	
	USB0_DM source current	V_{DM_SRC}	0.5	0.7	V	Output current = $250\ \mu\text{A}$	

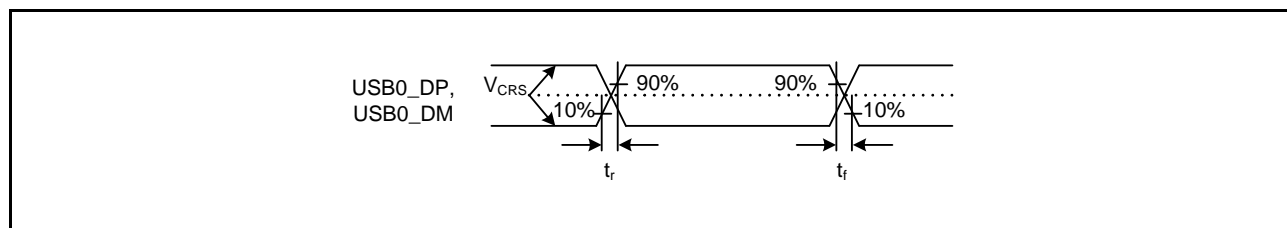


Figure 5.54 USB0_DP and USB0_DM Output Timing

Table 5.38 A/D Conversion Characteristics (2)

Conditions: $2.4\text{ V} \leq V_{CC} = V_{CC_USB} \leq 3.6\text{ V}$, $2.4\text{ V} \leq AV_{CC0} \leq 3.6\text{ V}$, $2.4\text{ V} \leq V_{REFH0} \leq AV_{CC0}$,
 $V_{SS} = AV_{SS0} = V_{REFL0} = V_{SS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		4	—	16	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 16 MHz)	Permissible signal source impedance (Max.) = 1.0 kΩ	2.062 (0.625)*2	—	—	μs	High-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 09h
		2.750 (1.313)*2	—	—	μs	Normal-precision channel ADCSR.ADHSC bit = 1 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±6.0	LSB	
Full-scale error		—	±1.25	±6.0	LSB	
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±3.0	±8.0	LSB	
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.5	±3.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

Table 5.39 A/D Conversion Characteristics (3)

Conditions: $1.8\text{ V} \leq V_{CC} = V_{CC_USB} \leq 3.6\text{ V}$, $1.8\text{ V} \leq AV_{CC0} \leq 3.6\text{ V}$, $1.8\text{ V} \leq V_{REFH0} \leq AV_{CC0}$,
 $V_{SS} = AV_{SS0} = V_{REFL0} = V_{SS_USB} = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item		Min.	Typ.	Max.	Unit	Test Conditions
Frequency		1	—	8	MHz	
Resolution		—	—	12	Bit	
Conversion time*1 (Operation at PCLKD = 8 MHz)	Permissible signal source impedance (Max.) = 5.0 kΩ	4.875 (1.250)*2	—	—	μs	High-precision channel ADCSR.ADHSC bit = 0 ADSSTRn.SST[7:0] bits = 09h
		6.250 (2.625)*2	—	—	μs	Normal-precision channel ADCSR.ADHSC bit = 0 ADSSTRn.SST[7:0] bits = 14h
Analog input effective range		0	—	VREFH0	V	
Offset error		—	±0.5	±24.0	LSB	
Full-scale error		—	±1.25	±24.0	LSB	
Quantization error		—	±0.5	—	LSB	
Absolute accuracy		—	±2.75	±32.0	LSB	
DNL differential nonlinearity error		—	±1.0	—	LSB	
INL integral nonlinearity error		—	±1.25	±12.0	LSB	

Note: The characteristics apply when no pin functions other than A/D converter input are used. Absolute accuracy includes quantization errors. Offset error, full-scale error, DNL differential nonlinearity error, and INL integral nonlinearity error do not include quantization errors.

Note 1. The conversion time is the sum of the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

Note 2. The value in parentheses indicates the sampling time.

Differential nonlinearity error (DNL)

Differential nonlinearity error is the difference between 1-LSB width based on the ideal A/D conversion characteristics and the width of the actual output code.

Offset error

Offset error is the difference between a transition point of the ideal first output code and the actual first output code.

Full-scale error

Full-scale error is the difference between a transition point of the ideal last output code and the actual last output code.

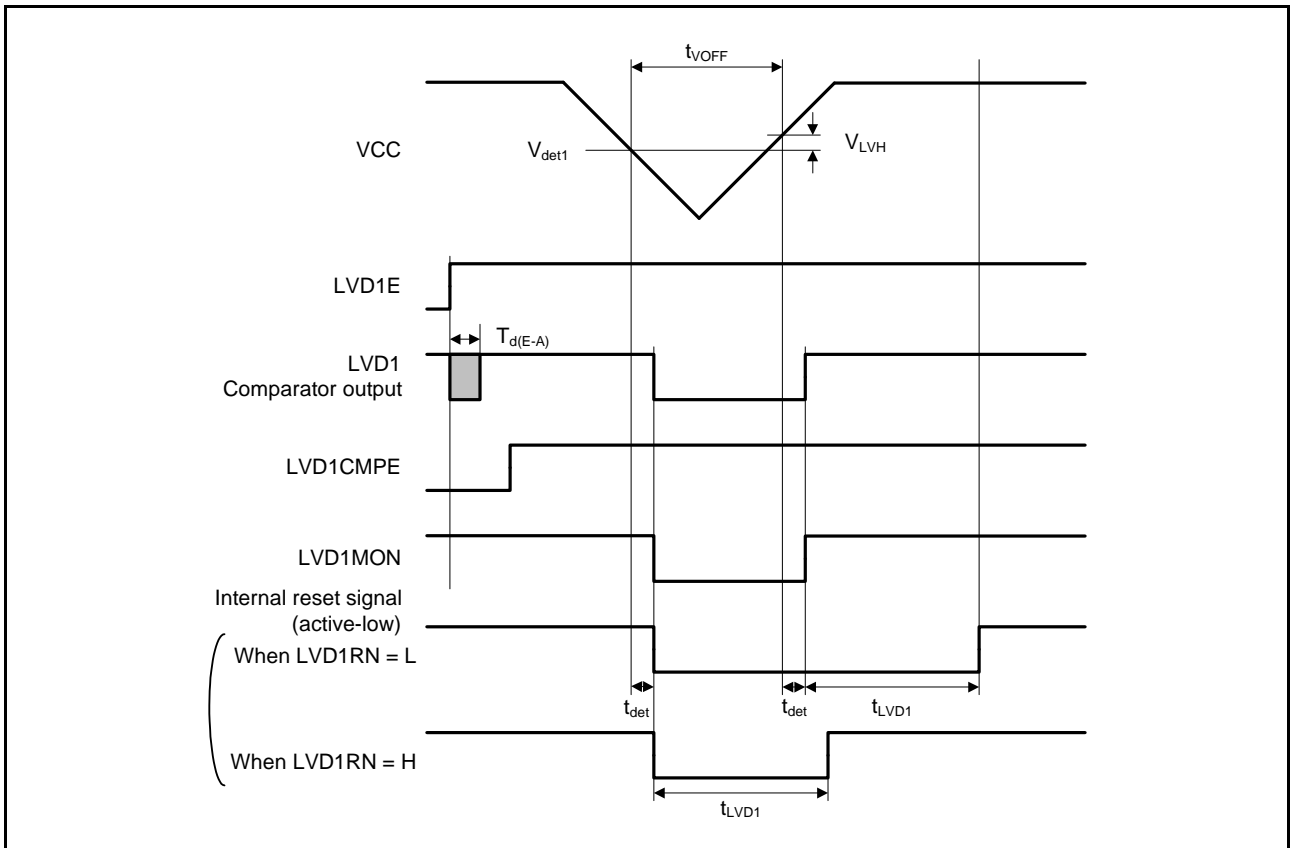


Figure 5.64 Voltage Detection Circuit Timing (V_{det1})

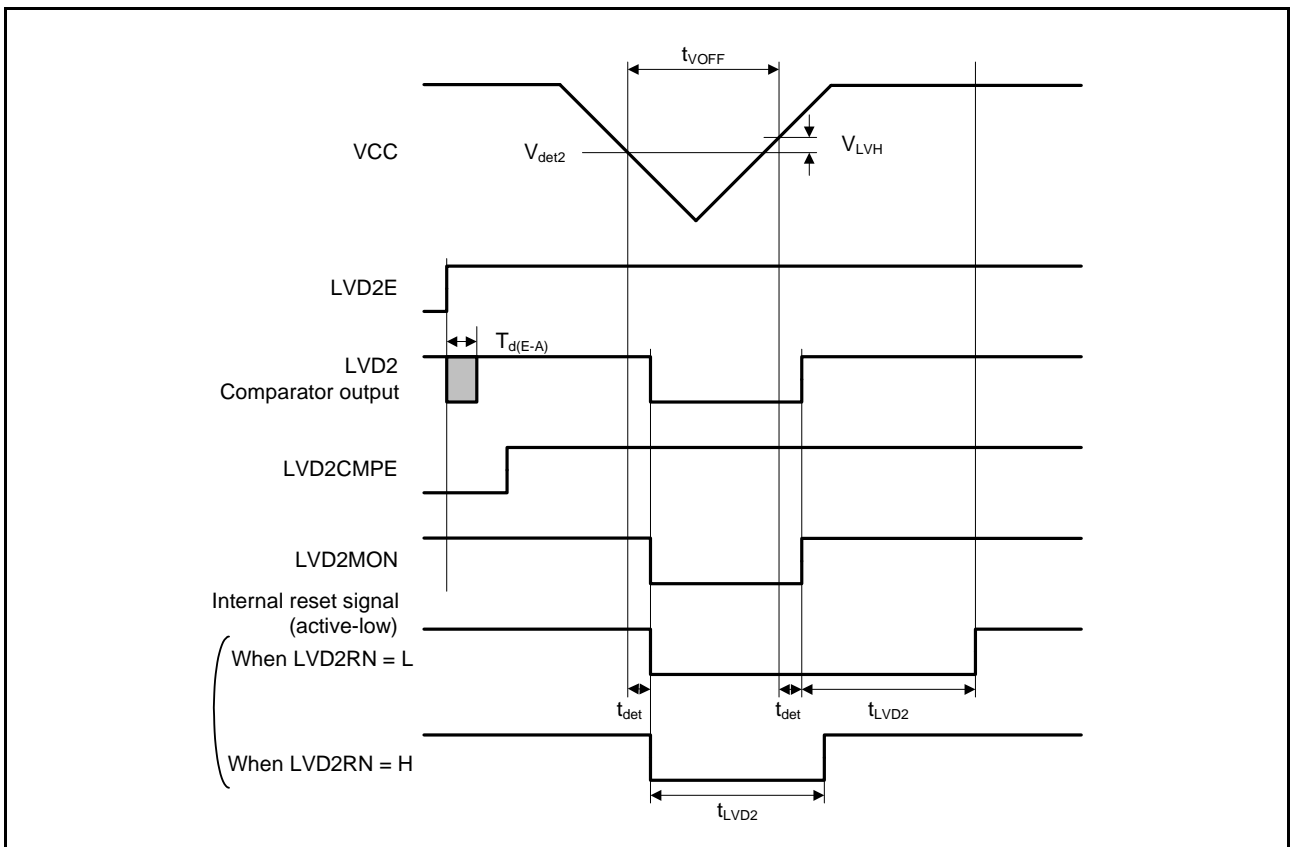


Figure 5.65 Voltage Detection Circuit Timing (V_{det2})

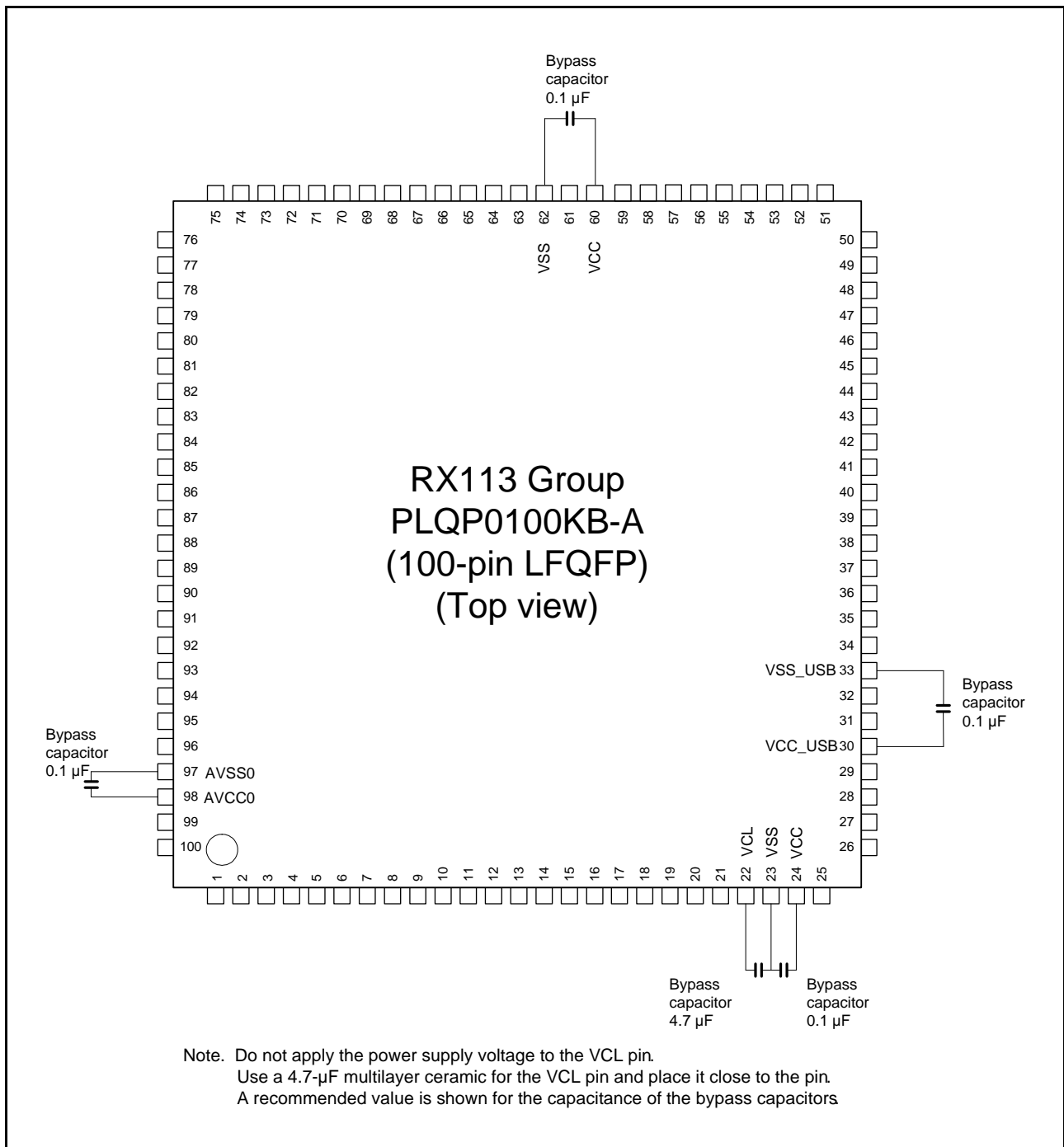


Figure 5.67 Connecting Capacitors (100-pin LQFP)